1. Layer 2 Switch - No.3

SPECIFICATION		Specification Offered by Bidder
Make :		
Model No. :		
Enclosure Type	e -1U	
Subtype - Gig	abit Ethernet	
Ports - 24x RJ4	5 10/100/1000Mb PoE+ auto-sensing ports, 4x SFP+ ports	
Authentication	Method - RADIUS, Secure Shell (SSH), Secure Shell v.2	
(SSH2), TACAC	S+	
RAM -1000 ME	3 or more.	
MAC Address	Table Size - 16K entries	
Switching Perfe	ormance fabric 128 Gbps	
switching Forw	varding performance 128 Mpps	
Status Indicato	rs - Port transmission speed, power	
Encryption Alg	orithm - SSL	
Routing Protoc	col - IGMP, IGMPv3	
-	Ethernet 100Base-TX, Ethernet 10Base-T	
	ack mountable	
Stackable		
Connectivity Technology - wired		
Features - BOOTP support, DHCP support, DiffServ support, IGMP		
snooping, VLAN support, auto-negotiation, auto-uplink (auto MDI/MDI-		
X), flow contro	I, full duplex capability, manageable, stackable, store and	
forward, uplinl	<	
	ndards - IEEE 802.1D, IEEE 802.1Q, IEEE 802.1p, IEEE	
802.1w, IEEE 802.1x, IEEE 802.3, IEEE 802.3ab, IEEE 802.3ad (LACP), IEEE		
	02.3x, IEEE 802.3z	
Ports Qty - 24		
Manageable - '	Yes	
Routing Protocol - IGMP, IGMPv3		
Switching Protocol - Ethernet		
Remote Management Protocol - HTTP, TFTP, Telnet		
Communicatio	n Mode - full-duplex	
Nominal Voltage - AC 120/230 V		
Frequency Required - 50/60 Hz		
Type - internal	power supply	
Compliant Standards - RoHS,		
Encryption Algorithm - SSL		
Connector Type - SFP (mini-GBIC)		
Comments - m	anagement	
	adapters, rails, screws and other accessories as may be	
needed, for mounting, power supply etc. to make the Switch		
operational.(A		
3Y warranty Support. The bidder must enclose along with Technical Bid		
(1) OEM authorization specific to this tender, and (2) technical		
compliance duly approved by the OEM, failing which the Bid offer will be		
rejected. Bidde	er should supply, installation and configuration.	